# XN04609 (XN4609)

# Silicon NPN epitaxial planer transistor (Tr1) Silicon PNP epitaxial planer transistor (Tr2)

For amplification of low frequency output (Tr1) For general amplification (Tr2)

### Features

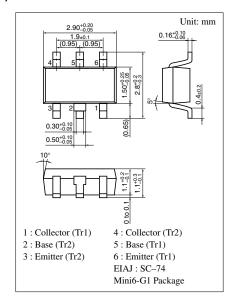
- Two elements incorporated into one package.
- Reduction of the mounting area and assembly cost by one half.

#### Basic Part Number of Element

• 2SD1328 + 2SB0709A(2SB709A)

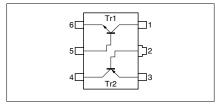
## Absolute Maximum Ratings (Ta=25°C)

-	Parameter	Symbol	Ratings	Unit
Tr1	Collector to base voltage	$V_{CBO}$	25	V
	Collector to emitter voltage	$V_{CEO}$	20	V
	Emitter to base voltage	$V_{EBO}$	12	V
	Collector current	$I_{C}$	0.5	A
	Peak collector current	$I_{CP}$	1	A
Tr2	Collector to base voltage	$V_{CBO}$	-60	V
	Collector to emitter voltage	V <sub>CEO</sub>	-50	V
	Emitter to base voltage	$V_{EBO}$	-7	V
	Collector current	$I_{C}$	-100	mA
	Peak collector current	$I_{CP}$	-200	mA
Overall	Total power dissipation	P <sub>T</sub>	300	mW
	Junction temperature	T <sub>j</sub>	150	°C
	Storage temperature	$T_{stg}$	-55 to +150	°C



Marking Symbol: 5F

#### Internal Connection



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# ■ Electrical Characteristics (Ta=25°C)

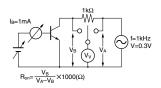
### • Tr1

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V <sub>CBO</sub>	$I_C = 10 \mu A, I_E = 0$	25			V
Collector to emitter voltage	V <sub>CEO</sub>	$I_C = 1 \text{ mA}, I_B = 0$	20			V
Emitter to base voltage	V <sub>EBO</sub>	$I_{\rm E} = 10 \mu A, I_{\rm C} = 0$	12			V
Collector cutoff current	$I_{CBO}$	$V_{CB} = 25V, I_{E} = 0$			0.1	μΑ
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = 2V, I_C = 0.5A^{*1}$	200		800	
Forward current transfer ratio	h <sub>FE2</sub>	$V_{CE} = 2V, I_C = 1A^{*1}$	60			
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 0.5A, I_B = 20mA$		0.13	0.4	V
Base to emitter saturation voltage	V <sub>BE(sat)</sub>	$I_C = 0.5A, I_B = 20mA$			1.2	V
Transition frequency	$f_T$	$V_{CB} = 10V, I_E = -50mA, f = 200MHz$		200		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10V, I_E = 0, f = 1MHz$		10		pF
ON Resistance	R <sub>on</sub> *2			1.0		Ω

### • Tr2

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V <sub>CBO</sub>	$I_C = -10\mu A, I_E = 0$	-60			V
Collector to emitter voltage	V <sub>CEO</sub>	$I_{\rm C} = -2mA, I_{\rm B} = 0$	-50			V
Emitter to base voltage	V <sub>EBO</sub>	$I_{\rm E} = -10\mu A, I_{\rm C} = 0$	-7			V
C 11 4 66	$I_{CBO}$	$V_{CB} = -20V, I_E = 0$			- 0.1	μA
Collector cutoff current	$I_{CEO}$	$V_{CE} = -10V, I_{E} = 0$			-100	μA
Forward current transfer ratio	$h_{FE}$	$V_{CE} = -10V, I_{C} = -2mA$	160		460	
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -100 \text{mA}, I_{\rm B} = -10 \text{mA}$		- 0.3		V
Transition frequency	$f_T$	$V_{CB} = -10V$ , $I_E = 1mA$ , $f = 200MHz$		80		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = -10V, I_E = 0, f = 1MHz$		2.7		pF

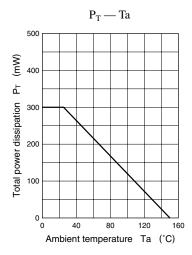
<sup>\*1</sup> Pulse measurement



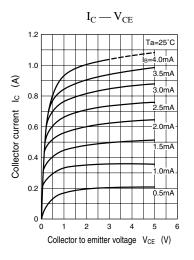
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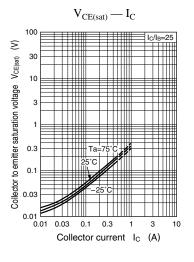
<sup>\*2</sup> Ron test circuit

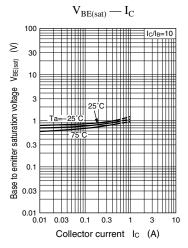
#### Common characteristics chart

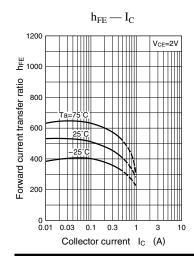


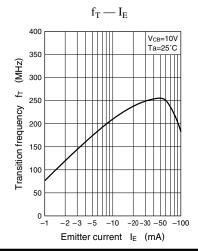
#### Characteristics charts of Tr1

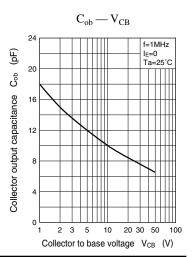




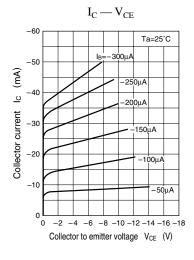


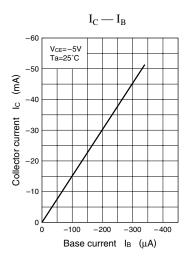


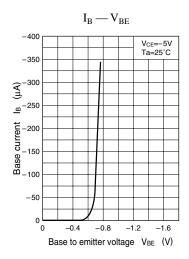


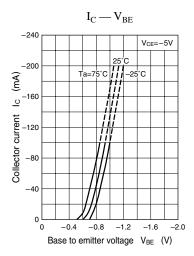


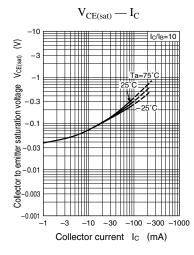
#### Characteristics charts of Tr2

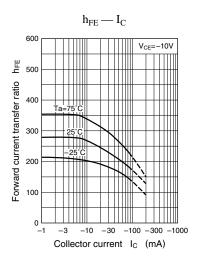


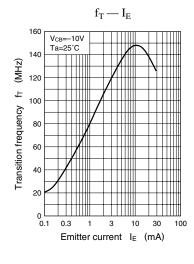


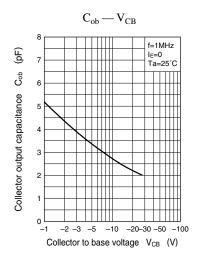


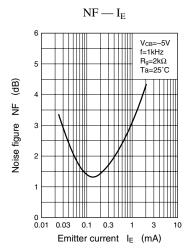




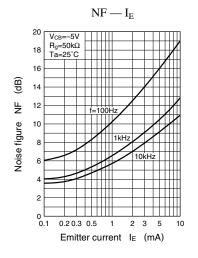


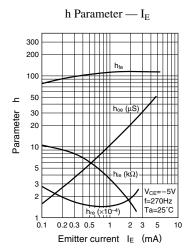


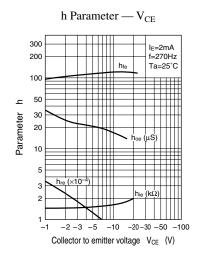




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